EAST Search History

| Ref # | Hits | Search Query | DBs | Default Operator | Plurals | Time Stamp |
|----------|------|--|---|---------------------|------------------|------------------|
| L1 | 8446 | "17" and ((wet adj etch\$3) same (HF or hydrofluoric)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/18 02:02 |
| L2 | 4 | "L17" and ((wet adj etch\$3) same (HF or hydrofluoric)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF ⁻ | 2007/04/18 02:02 |
| L3 | 62 | polyimide near10 (wet adj etch\$3) and (HF or hydrofluoric) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR . | OFF | 2007/04/18 02:04 |
| L4 | 62 | (polyimide near10 (wet adj etch\$3)) and (HF or hydrofluoric) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/18 02:17 |
| L5 | 2 | ("6700631").PN. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/18 02:17 |
| S1 . | 11 | "6700631" | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/17 16:10 |
| S2 | 2 | ("6700631").PN. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/17 16:13 |
| S3 | 917 | (ion\$1 near2 implant\$3) same (SiC or (silicon near carbide)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/17 16:15 |
| S4 | 331 | S3 and (ion\$1 near2 implant\$3) same temperature | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR · | OFF | 2007/04/17 16:14 |

EAST Search History

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|-----|------|---|---|------|-----|------------------|
| S5 | 140 | S4 and (ion\$1 near2 implant\$3) near10 temperature | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR . | OFF | 2007/04/17 16:14 |
| S6 | 94 | S5 and ((ion\$1 near2 implant\$3) near10 (SiC or (silicon near carbide))) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR . | OFF | 2007/04/17 16:17 |
| S7 | 94 | S6 and temperature | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/17 16:18 |
| S8 | 60 | S7 and ((sic or (silicon near carbide)) near4 substrate) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/17 18:40 |
| S9 | . 2 | ("5628871").PN. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/17 21:07 |
| S10 | 5206 | photosensitive near2 polyimide | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/17 18:41 |
| S11 | 3016 | S10 and resin | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/17 18:41 |
| S12 | 652 | S11 and polyimide.clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/17 18:42 |
| S13 | 443 | S12 and resin.clm. | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/17 18:42 |
| S14 | 89 | (ion\$1 near2 implant\$3) and (polyimide near3 mask) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/17 20:06 |

EAST Search History

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|---------------|-----|---|---|----|-----|------------------|
| S15 | 21 | S14 not photoresist not ((dry adj etch\$3) or RIE or (plasma adj etch\$3)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/17 20:19 |
| S16 | 1 | 10/528440 | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/17 20:19 |
| S17 | 430 | polyimide near10 (wet adj etch\$3) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/18 02:04 |
| S18 | 30 | S17 and (SiC or (silicon near carbide)) | US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB | OR | OFF | 2007/04/17 22:01 |